



YEA SHIN TECHNOLOGY CO., LTD

YSE2210VBB

Dual N-Channel Enhancement MOSFET

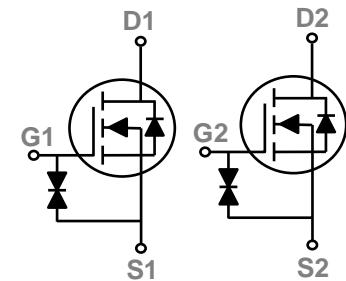
VDS= 20V, ID= 12A



Features

- 20V, 30A, $R_{DS(ON)} = 12m\Omega$ @ $V_{GS} = 10V$
- Improved dv/dt capability
- ESD Protection Diode Embedded
- Green Device Available

PPAK3x3 Dual Pin Configuration



Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2nd SR
- Li-Battery Protection

Absolute Maximum Rating $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 10	V
I_D	Drain Current – Continuous ($T_c=25^\circ C$)	30	A
	Drain Current – Continuous ($T_c=100^\circ C$)	19	A
I_{DM}	Drain Current – Pulsed ¹	120	A
P_D	Power Dissipation ($T_c=25^\circ C$)	26	W
	Power Dissipation – Derate above 25°C	0.21	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	4.8	°C/W

DEVICE CHARACTERISTICS

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Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	20	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	---	0.02	---	$\text{V}/^\circ\text{C}$
I_{DS}	Drain-Source Leakage Current	$V_{\text{DS}}=20\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{DS}}=16\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=85^\circ\text{C}$	---	---	10	μA
I_{GS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 10\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 10	μA

On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-source On-Resistance	$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=10\text{A}$	---	10	12	$\text{m}\Omega$
		$V_{\text{GS}}=4.2\text{V}$, $I_{\text{D}}=10\text{A}$	---	10.1	12.2	$\text{m}\Omega$
		$V_{\text{GS}}=3.7\text{V}$, $I_{\text{D}}=9\text{A}$	---	10.3	12.5	$\text{m}\Omega$
		$V_{\text{GS}}=3.0\text{V}$, $I_{\text{D}}=9\text{A}$	---	10.7	13.2	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}$, $I_{\text{D}}=8\text{A}$	---	11.4	14.5	$\text{m}\Omega$
		$V_{\text{GS}}=1.8\text{V}$, $I_{\text{D}}=8\text{A}$	---	15	20	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_{\text{D}}=250\mu\text{A}$	0.3	0.6	1.0	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	2	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=5\text{A}$	---	12	---	S

Dynamic and Switching Characteristics

Q_g	Total Gate Charge ^{2,3}	$V_{\text{DS}}=10\text{V}$, $V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=5\text{A}$	---	16.9	26	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	1.1	3	
Q_{gd}	Gate-Drain Charge ^{2,3}		---	4	7	
$T_{\text{d(on)}}$	Turn-On Delay Time ^{2,3}	$V_{\text{DD}}=10\text{V}$, $V_{\text{GS}}=4.5\text{V}$, $R_{\text{G}}=25\Omega$, $I_{\text{D}}=1\text{A}$	---	6.8	13	ns
T_r	Rise Time ^{2,3}		---	20	38	
$T_{\text{d(off)}}$	Turn-On Delay Time ^{2,3}		---	41.8	79	
T_f	Fall Time ^{2,3}		---	13.2	25	
C_{iss}	Input Capacitance		---	1020	1480	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=10\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	160	240	
C_{rss}	Reverse Transfer Capacitance		---	110	160	
R_g	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1\text{MHz}$	---	2	4	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	30	A
I_{SM}	Pulsed Source Current		---	---	60	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

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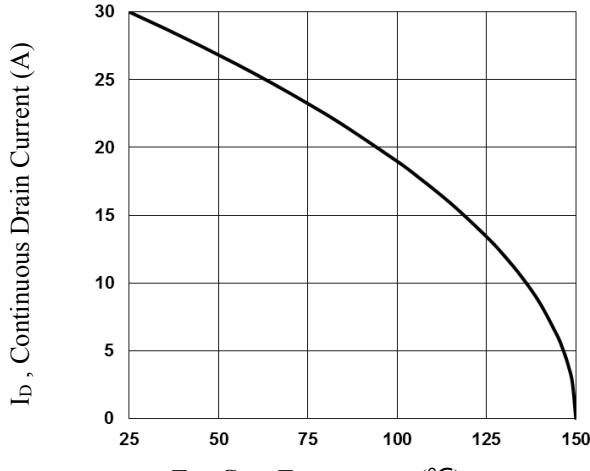


Fig.1 Continuous Drain Current vs. T_c

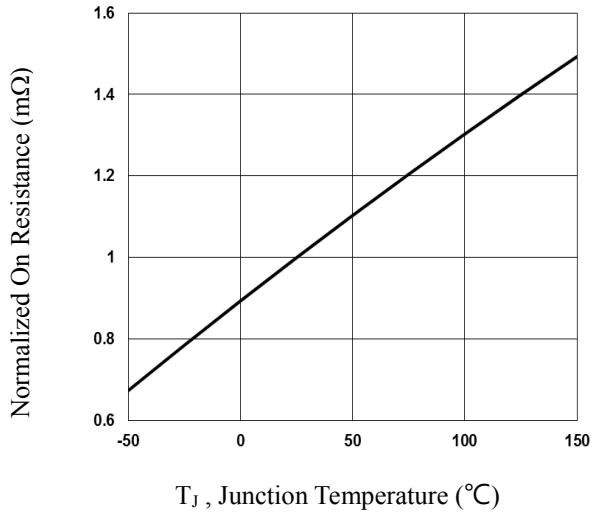


Fig.2 Normalized RDS(on) vs. T_j

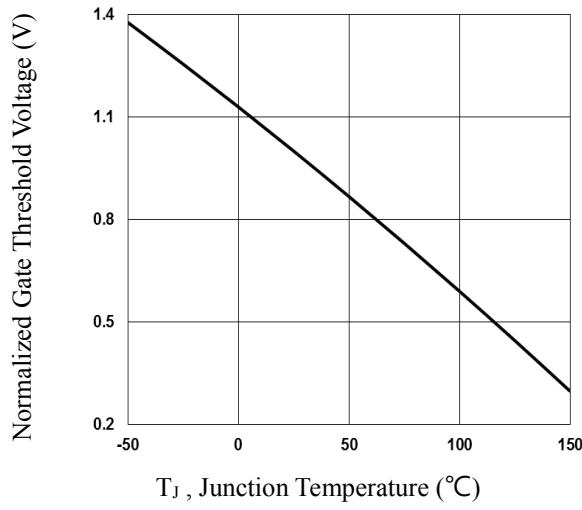


Fig.3 Normalized V_{th} vs. T_j

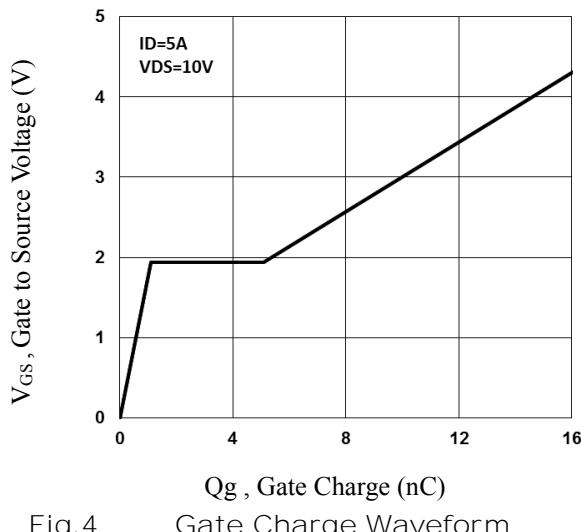


Fig.4 Gate Charge Waveform

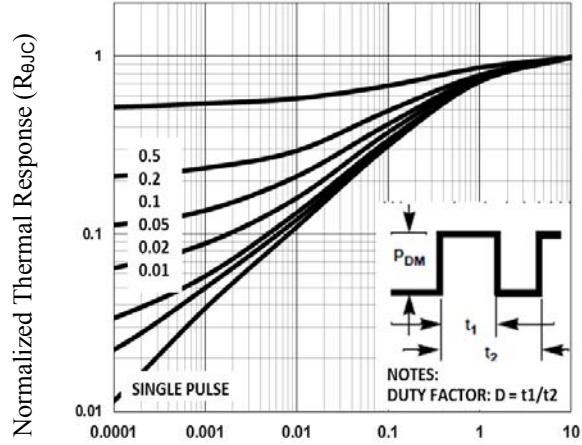


Fig.5 Normalized Transient Impedance

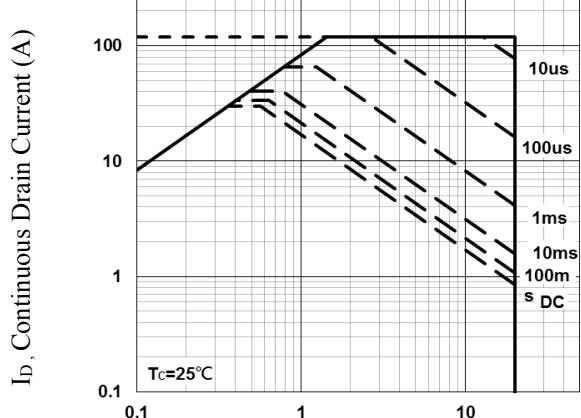


Fig.6 Maximum Safe Operation Area

DEVICE CHARACTERISTICS

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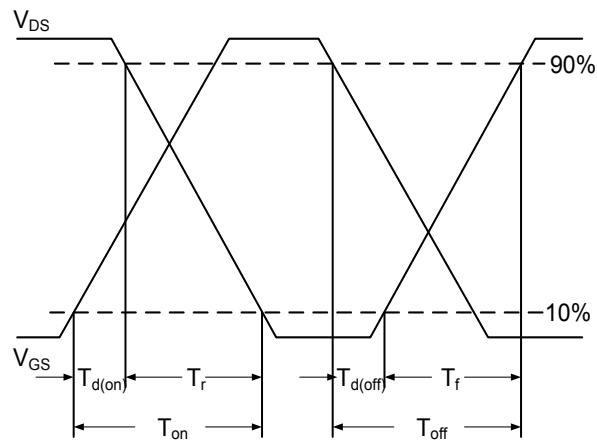


Fig.7 Switching Time Waveform

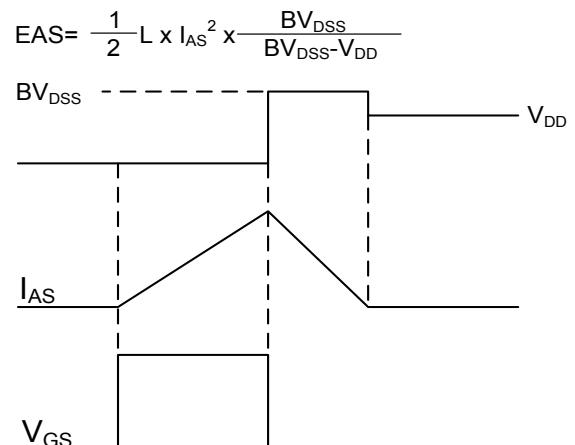
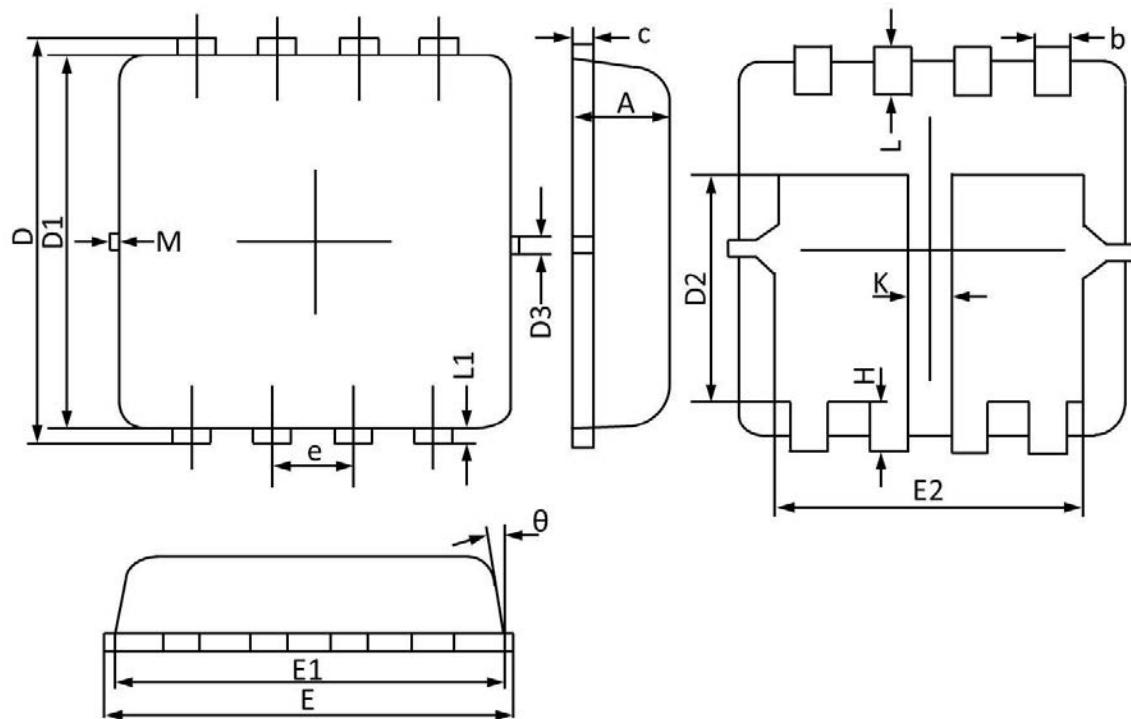


Fig.8 EAS Waveform

PACKAGE OUTLINE & DIMENSIONS

YSE2210VBB

PPAK3x3 Dual PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
b	0.250	0.350	0.010	0.013
c	0.100	0.250	0.004	0.009
D	3.250	3.450	0.128	0.135
D1	3.000	3.200	0.119	0.125
D2	1.780	1.980	0.070	0.077
D3	0.130 REF		0.005 REF	
E	3.200	3.400	0.126	0.133
E1	3.000	3.200	0.119	0.125
E2	2.390	2.590	0.094	0.102
e	0.650 BSC		0.026 BSC	
H	0.300	0.500	0.011	0.019
L	0.300	0.500	0.011	0.019
L1	0.130 REF		0.005 REF	
K	0.300 REF		0.012 REF	
θ	0°	12°	0°	12°
M	0.150 REF		0.006 REF	